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### Pch -30V -10A Power MOSFET

$V_{\mathrm{DSS}}$	-30V
R <sub>DS(on)</sub> (Max.)	12.6m $Ω$
I <sub>D</sub>	-10A
$P_D$	2.0W

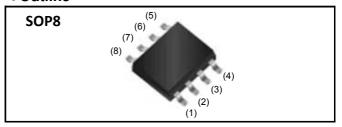
# ● Features

- 1) Low on resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small Surface Mount Package (SOP8).
- 4) Pb-free lead plating; RoHS compliant

## Application

DC/DC Converter

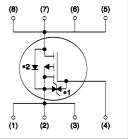
#### Outline



### •Inner circuit

- (1) Source(2) Source
- (5) Drain (6) Drain
- (3) Source
- (7) Drain
- (4) Gate
- (8) Drain





Packaging specifications

	Packaging	Taping
	Reel size (mm)	330
Typo	Tape width (mm)	12
Туре	Basic ordering unit (pcs)	2,500
	Taping code	ТВ
	Marking	RRH100P03

## ● Absolute maximum ratings(T<sub>a</sub> = 25°C)

Parameter	Symbol	Value	Unit
Drain - Source voltage	$V_{DSS}$	-30	V
Continuous drain current	I <sub>D</sub> *1	±10	А
Pulsed drain current	I <sub>D,pulse</sub> *2	±40	А
Gate - Source voltage	$V_{GSS}$	±20	V
Avalanche energy, single pulse	E <sub>AS</sub> *3	0.8	mJ
Dower dissination	P <sub>D</sub> *4	2.0	W
Power dissipation	$P_{D}^{*5}$	0.65	W
Junction temperature	T <sub>j</sub>	150	°C
Range of storage temperature	T <sub>stg</sub>	−55 to +150	°C

### ●Thermal resistance

Parameter	Symbol	Values			Unit
- Farametei	Зуппоп	Min.	Тур.	Max.	Offic
Thermal resistance, junction - ambient	R <sub>thJA</sub> *4	-	-	62.5	°C/W
Thermal resistance, junction - ambient	R <sub>thJA</sub> *5	-	-	192	°C/W

## •Electrical characteristics( $T_a = 25$ °C)

Parameter	Symbol	Conditions	Values			Unit
r ai ai i letei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V$ , $I_D = -1mA$	-30	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	I <sub>D</sub> = -1mA referenced to 25°C	1	-25	1	mV/°C
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = -30V, V_{GS} = 0V$	ı	-	-1	μΑ
Gate - Source leakage current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	±10	μΑ
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = -10V, I_{D} = -1mA$	-1.0	-	-2.5	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{(GS)th}}{\Delta T_{j}}$	I <sub>D</sub> = -1mA referenced to 25°C	-	3.9	-	mV/°C
		$V_{GS} = -10V, I_D = -10A$	-	9.0	12.6	
Static drain - source	R <sub>DS(on)</sub> *6	$V_{GS}$ = -4.5V, $I_{D}$ = -5A	-	12.5	17.5	mΩ
on - state resistance		$V_{GS} = -4.0V, I_D = -5A$	-	14.0	19.6	11122
		V <sub>GS</sub> = -10V, I <sub>D</sub> = -10A, T <sub>j</sub> =125°C	ı	14.0	20.0	
Gate input resistannce	$R_{G}$	f = 1MHz, open drain	-	3.0	-	Ω
Transconductance	${\sf g_{fs}}^{*6}$	$V_{DS} = -10V, I_{D} = -10A$	13	26	-	S

<sup>\*1</sup> Limited only by maximum temperature allowed.

<sup>\*2</sup> Pw  $\leq$  10  $\mu s,~Duty~cycle \leq$  1%

<sup>\*3</sup> L  $\simeq$  10 $\mu$ H, V<sub>DD</sub> = -15V, Rg = 25 $\Omega$ , starting T<sub>i</sub> = 25 $^{\circ}$ C

<sup>\*4</sup> Mounted on a ceramic board (30×30×0.8mm)

<sup>\*5</sup> Mounted on a FR4 (20×20×0.8mm)

# • Electrical characteristics ( $T_a = 25$ °C)

Parameter	Symbol	Conditions		Unit		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	3600	-	
Output capacitance	$C_{oss}$	V <sub>DS</sub> = -10V	-	450	-	pF
Reverse transfer capacitance	$C_{rss}$	f = 1MHz	-	450	-	
Turn - on delay time	t <sub>d(on)</sub> *6	$V_{DD} \simeq -15V, V_{GS} = -10V$	ı	25	-	
Rise time	t <sub>r</sub> *6	$I_D = -5A$	-	60	-	no
Turn - off delay time	${\rm t_{d(off)}}^{*6}$	$R_L = 3.0\Omega$	-	150	-	ns
Fall time	t <sub>f</sub> *6	$R_G = 10\Omega$	-	100	-	

# •Gate Charge characteristics( $T_a = 25$ °C)

Parameter	Symbol	Conditions	Values			Unit
Parameter		Conditions	Min.	Тур.	Max.	Offic
Total gate charge	${\sf Q_g}^{*6}$	$V_{DD}^{\sim} -15V, I_{D} = -10A$ $V_{GS} = -5V$	-	39	-	
Total gate charge		$V_{DD}^{\sim} -15V, I_{D} = -10A$ $V_{GS} = -10V$	-	68	-	nC
Gate - Source charge	Q <sub>gs</sub> *6	$V_{DD}^{\sim} -15V, I_{D} = -10A$ $V_{GS} = -5V$	1	8.5	-	
Gate - Drain charge	Q <sub>gd</sub> *6	$V_{GS} = -5V$	-	13.5	-	

# ●Body diode electrical characteristics (Source-Drain)(T<sub>a</sub> = 25°C)

Parameter	Cymbol	Conditions	Values			Unit
- Faranietei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Inverse diode continuous, forward current	l <sub>S</sub> *1	T <sub>a</sub> = 25°C	-	-	-1.6	Α
Forward voltage	V <sub>SD</sub> *6	$V_{GS} = 0V, I_{s} = -10A$	_	-	-1.2	V
Reverse recovery time	t <sub>rr</sub> *6	I <sub>S</sub> = -10A	ı	40	80	ns
Reverse recovery charge	Q <sub>rr</sub> *6	di/dt = 100A / μs	ı	35	70	μС

<sup>\*6</sup> Pulsed

Fig.1 Power Dissipation Derating Curve

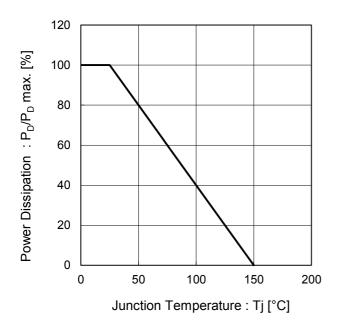


Fig.2 Maximum Safe Operating Area

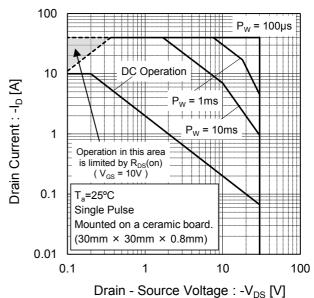
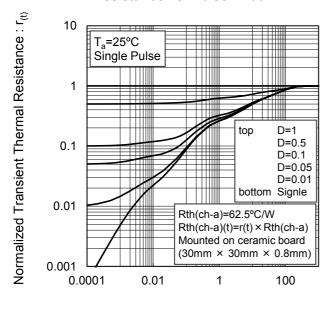
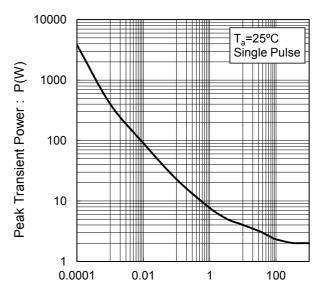


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width



Pulse Width :  $P_W$  [s]

Fig.4 Single Pulse Maxmum Power dissipation



Pulse Width: P<sub>W</sub> [s]

Fig.5 Avalanche Current vs Inductive Load

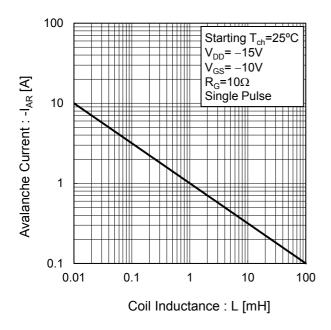


Fig.6 Avalanche Energy Derating Curve vs Junction Temperature

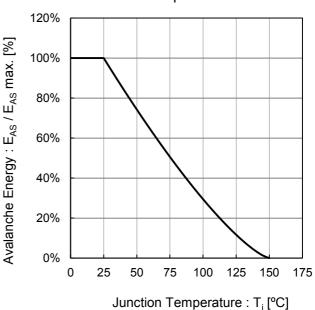


Fig.7 Typical Output Characteristics(I)

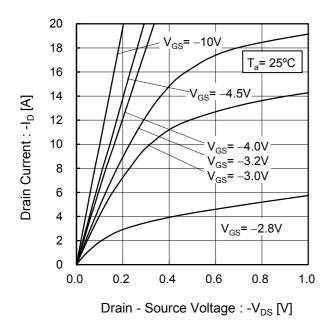
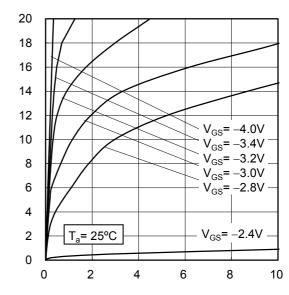


Fig.8 Typical Output Characteristics(II)



Drain Current: -l<sub>D</sub> [A]

Fig.9 Breakdown Voltage

vs. Junction Temperature

Vestor Inches | Source |

Vestor Inches | So

Fig.10 Typical Transfer Characteristics

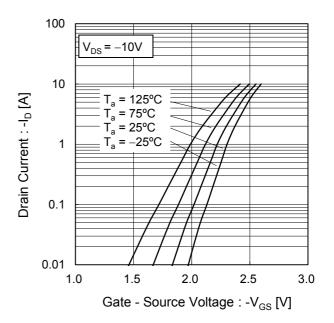


Fig.11 Gate Threshold Voltage vs. Junction Temperature

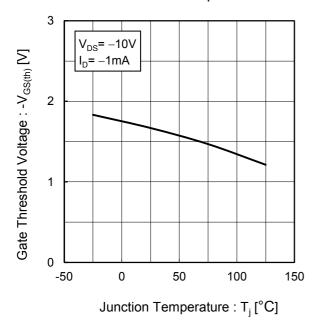


Fig.12 Transconductance vs. Drain Current

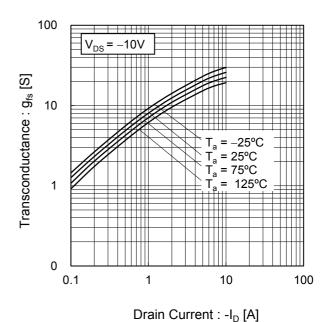


Fig.13 Drain CurrentDerating Curve

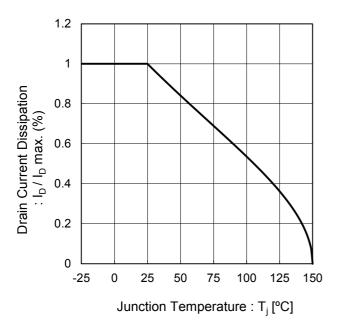
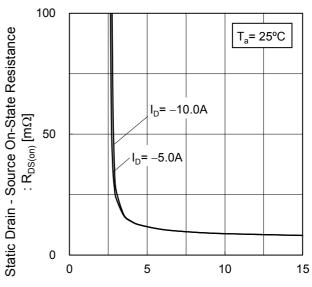


Fig.14 Static Drain - Source On - State Resistance vs. Gate Source Voltage



Gate - Source Voltage : -V<sub>GS</sub> [V]

Fig.15 Static Drain - Source On - State Resistance vs. Drain Current(I)

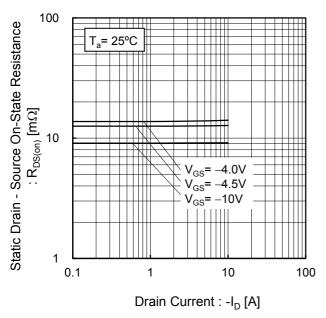
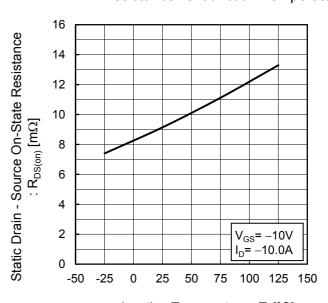


Fig.16 Static Drain - Source On - State Resistance vs. Junction Temperature



Junction Temperature : T<sub>i</sub> [°C]

Fig.17 Static Drain - Source On - State Fig.18 Static Drain - Source On - State Resistance vs. Drain Current(II) Resistance vs. Drain Current(III) 100 100 Static Drain - Source On-State Resistance Static Drain - Source On-State Resistance -10V  $:R_{\mathsf{DS}(\mathsf{on})}\left[ \mathsf{m}\Omega\right]$  $: R_{\mathsf{DS}(\mathsf{on})} \left[ \mathsf{m} \Omega \right]$ 10 10 = 125°C  $T_a = 75^{\circ}C$   $T_a = 25^{\circ}C$ T<sub>a</sub> = 125°C = 75°C T<sub>a</sub> = 25°C  $T_a = -25$ °C  $T_a = -25^{\circ}C$ 1 0.1 10 0.1 1 10 100 1 100 Drain Current : -I<sub>D</sub> [A] Drain Current : -I<sub>D</sub> [A]

Resistance vs. Drain Current(IV)

100  $V_{GS} = -4.0V$   $V_{GS}$ 

Fig.19 Static Drain - Source On - State

Drain Current : -I<sub>D</sub> [A]

Fig.20 Typical Capacitance vs. Drain - Source Voltage 10000 +++++ $C_{iss}$ Capacitance: C [pF] 1000  $\mathsf{C}_{\mathsf{rss}}$  $C_{\text{oss}}$ 100  $T_a = 25^{\circ}C$ f=1MHz  $V_{GS}=0V$ 10 0.01 0.1 10 100 Drain - Source Voltage : - $V_{DS}$  [V]

Fig.21 Switching Characteristics

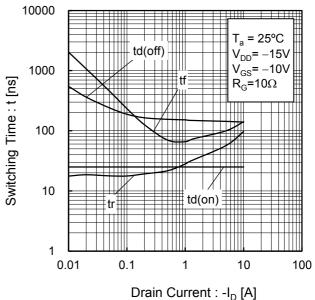


Fig.22 Dynamic Input Characteristics

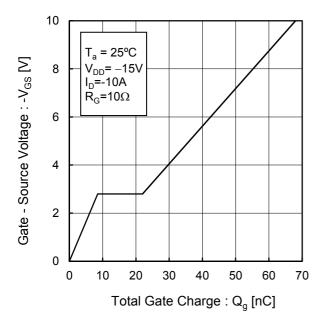
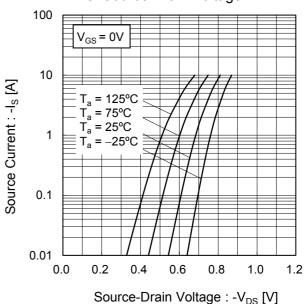


Fig.23 Source Current vs. Source Drain Voltage



### Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

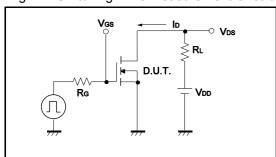


Fig.2-1 Gate Charge Measurement Circuit

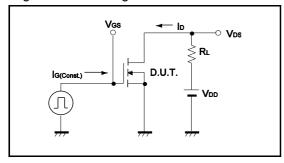


Fig.3-1 Avalanche Measurement Circuit

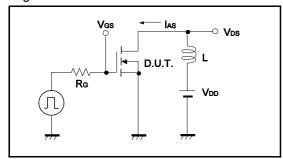


Fig.1-2 Switching Waveforms

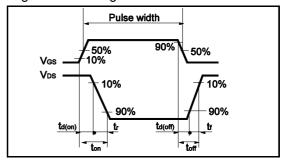


Fig.2-2 Gate Charge Waveform

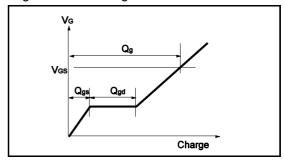
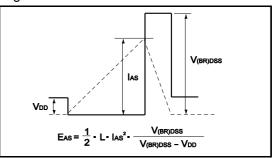
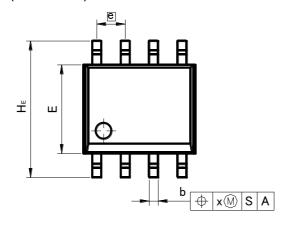


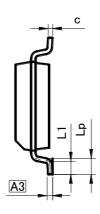
Fig.3-2 Avalanche Waveform

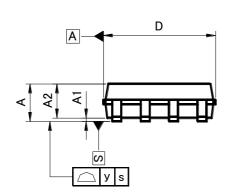


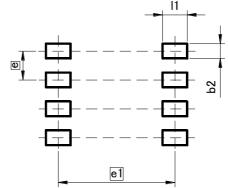
## ●Dimensions (Unit : mm)











### Patterm of terminal position areas

DIM	MILIMI	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	-	1.75	_	0.069
A1	0.	15	0.0	006
A2	1.40	1.60	0.055	0.063
A3	0.2	25	0.0	01
b	0.30	0.50	0.012	0.02
С	0.10	0.30	0.004	0.012
D	4.80	5.20	0.189	0.205
Е	3.75	4.05	0.148	0.159
е	1.2	27	0.0	05
HE	5.70	6.30	0.224	0.248
L1	0.50	0.70	0.02	0.028
Lp	0.65	0.85	0.026	0.033
х	0.15		0.0	006
у	0.10		0.0	004

DIM	MILIMETERS MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
b2	_	0.65	- 0.026	
e1	5.	15 0.203		03
l1	_	1.15	_	0.045

### Dimension in mm/inches

#### Notes

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